OSRAM LE RTDCY S2WN

Datasheet

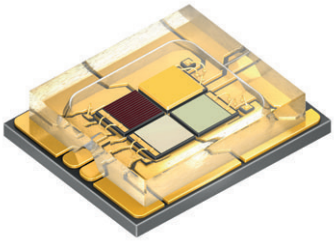
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OSRAM

OSRAM OSTAR™ Stage

LE RTDCY S2WN

Compact lightsource in SMT technology, glass window on top, RoHS compliant



Applications

- Entertainment

Features

- Package: compact lightsource in multi chip SMT technology with glass window on top
- Chip technology: Thinfilm / UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 625 nm (● red); λ_{dom} = 525 nm (● true green); λ_{dom} = 453 nm (● deep blue); Cx = 0.57, Cy = 0.42 acc. to CIE 1931 (● converted yellow)
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Brightness [1]	Ordering Code
LERTDCYS2WN-KBLA-1+MANA-P+AXAZ-P+LBMB-YS		Q65112A5476
● red	● Φ_V = 90 ... 140 lm (I_F = 1000 mA)	
● true green	● Φ_V = 180 ... 355 lm (I_F = 1000 mA)	
● deep blue	● Φ_E = 1120 ... 1800 mW (I_F = 1000 mA)	
● converted yellow	● Φ_V = 140 ... 280 lm (I_F = 1000 mA)	

Maximum Ratings

Parameter	Symbol		Values ● red	Values ● true green	Values ● deep blue	Values ● converted yellow
Operating Temperature	T_{op}	min. max.	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C	-40 °C 85 °C
Junction Temperature	T_j	max.	125 °C	150 °C	150 °C	150 °C
Forward Current T_S = 25 °C	I_F	min. max.	40 mA 2500 mA	40 mA 3000 mA	40 mA 3000 mA	40 mA 3000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV	2 kV	2 kV	2 kV
Reverse current [2)]	I_R	max.	200 mA	200 mA	200 mA	200 mA

Characteristics

I_F = 1000 mA; T_S = 25 °C

Parameter	Symbol		Values ● red	Values ● true green	Values ● deep blue	Values ● converted yellow
Chromaticity Coordinate [3]	Cx Cy	typ. typ.				0.57 0.42
Peak Wavelength	λ_{peak}	typ.	633 nm	519 nm	448 nm	
Dominant Wavelength [4]	λ_{dom}	min. typ. max.	620 nm 625 nm 632 nm	519 nm 525 nm 531 nm	449 nm 453 nm 458 nm	
Spectral bandwidth at 50% $I_{rel,max}$	$\Delta\lambda$	typ.	16 nm	31 nm	18 nm	
Viewing angle at 50% I_V	2φ	typ.	120 °	120 °	120 °	130 °
Radiating surface For value(s) see red column, all chips operated simultaneously	A_{color}	typ.	2.1 x 2.1 mm²			
Partial Flux acc. CIE 127:2007 [5] $\Phi_{E/V\ 120°} = x * \Phi_{E/V\ 180°}$	$\Phi_{E/V,\ 120°}$	typ.	0.82	0.82	0.82	0.77
Forward Voltage [6] I_F = 1000 mA	V_F	min. typ. max.	1.85 V 2.35 V 2.80 V	2.30 V 2.90 V 3.30 V	2.70 V 3.00 V 3.40 V	2.70 V 3.00 V 3.40 V
Reverse voltage (ESD device)	$V_{R\ ESD}$	min.	45 V	45 V	45 V	45 V
Reverse voltage [2] I_R = 20 mA	V_R	max.	1.2 V	1.2 V	1.2 V	1.2 V
Real thermal resistance junction/solderpoint [7] For value(s) see red column, all chips operated simultaneously	$R_{thJS\ real}$	typ. max.	1.20 K / W 1.40 K / W			
Electrical thermal resistance junction/solderpoint [7] With efficiency η_e = 26%; for value(s) see red column, all chips operated simultan.	$R_{thJS\ elec.}$	typ. max.	0.89 K / W 1.04 K / W			

Brightness Groups

Color of emission	Group	Luminous Flux [1] I_F = 1000 mA min. Φ_V	Luminous Flux [1] I_F = 1000 mA max. Φ_V
red	KB	90 lm	112 lm
red	LA	112 lm	140 lm
true green	MA	180 lm	224 lm
true green	MB	224 lm	280 lm
true green	NA	280 lm	355 lm
deep blue	AX	1120 mW	1300 mW
deep blue	AY	1300 mW	1500 mW
deep blue	AZ	1500 mW	1800 mW
converted yellow	LB	140 lm	180 lm
converted yellow	MA	180 lm	224 lm
converted yellow	MB	224 lm	280 lm

Wavelength Groups

true green

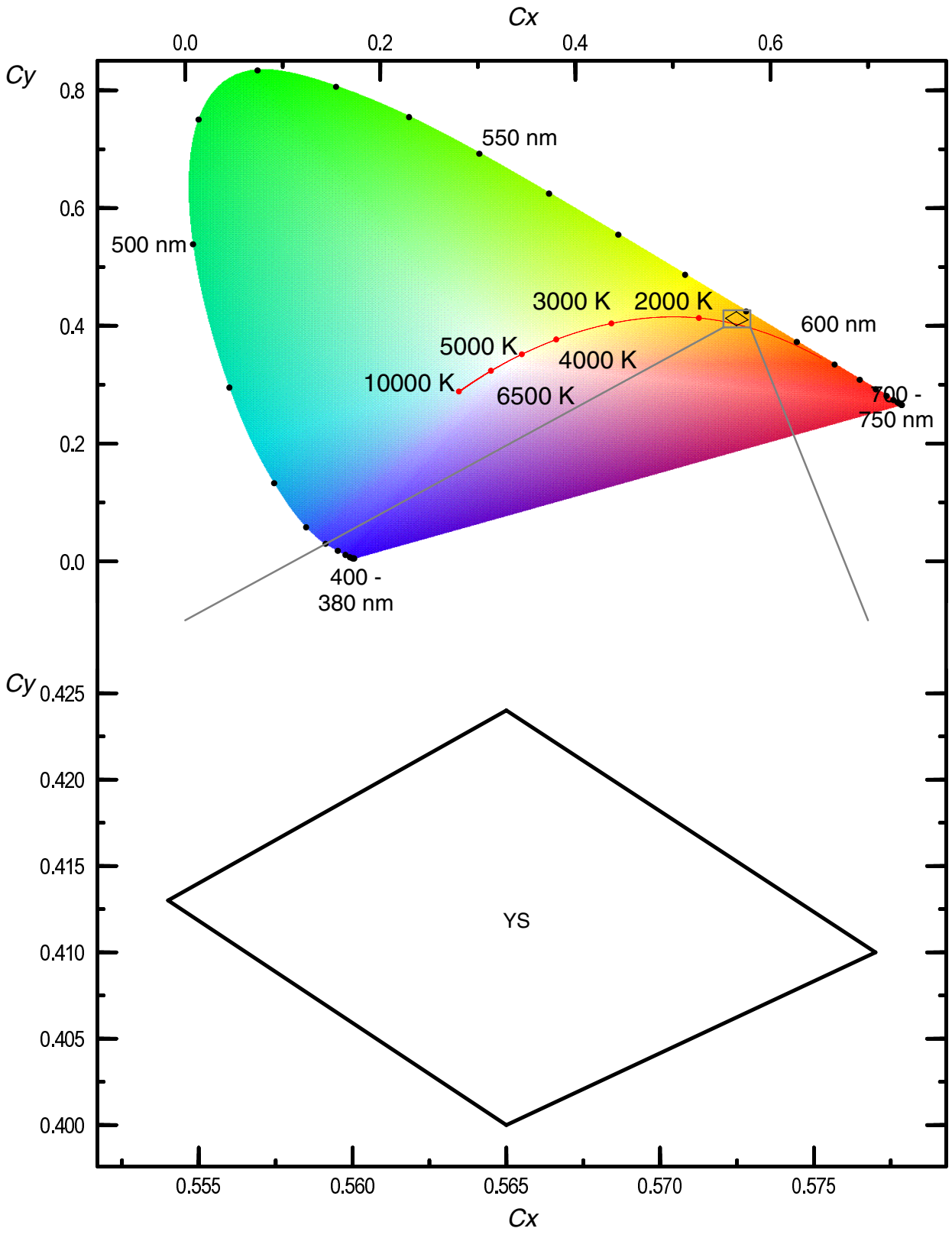
Group	Dominant Wavelength [4] min. λ_{dom}	Dominant Wavelength [4] max. λ_{dom}
3	519 nm	525 nm
4	525 nm	531 nm

Wavelength Groups

deep blue

Group	Dominant Wavelength [4] min. λ_{dom}	Dominant Wavelength [4] max. λ_{dom}
3	449 nm	453 nm
4	453 nm	458 nm

Chromaticity Coordinate Groups



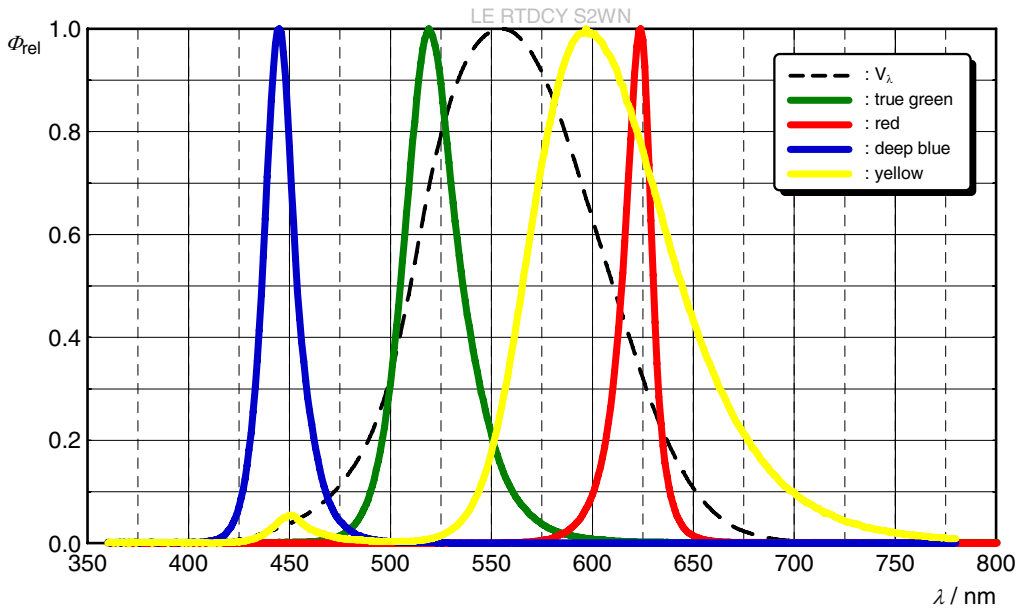
Chromaticity Coordinate Groups [3)]

- converted yellow

Group	Cx	Cy
YS	0.5650	0.4240
	0.5770	0.4100
	0.5650	0.4000
	0.5540	0.4130

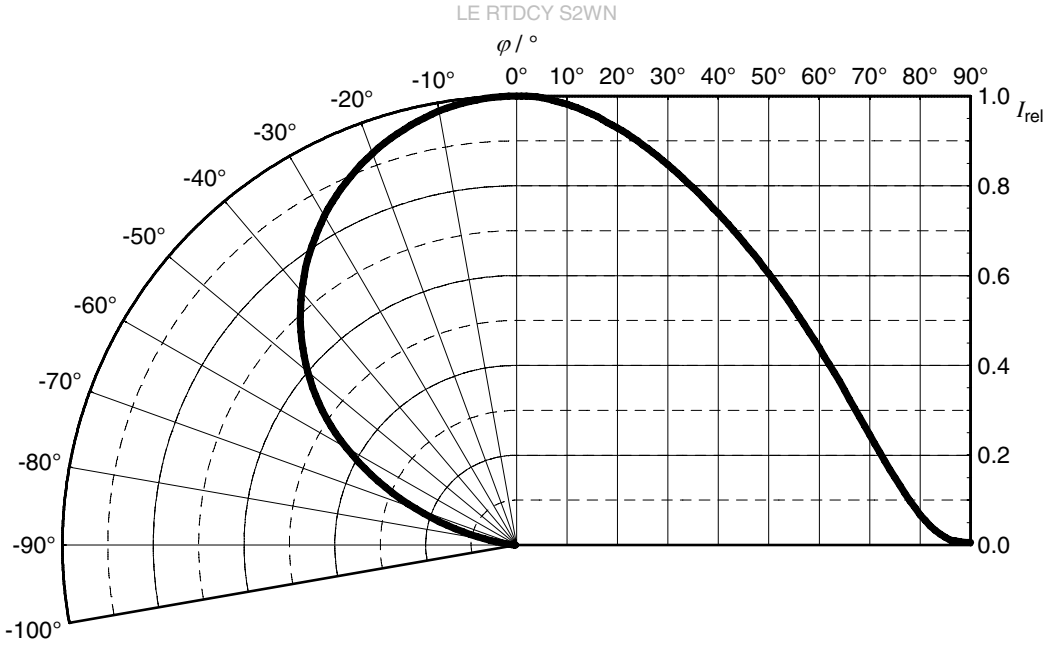
Relative Spectral Emission [5)]

$\Phi_{rel} = f(\lambda)$; I_F = 1000 mA; T_J = 25 °C



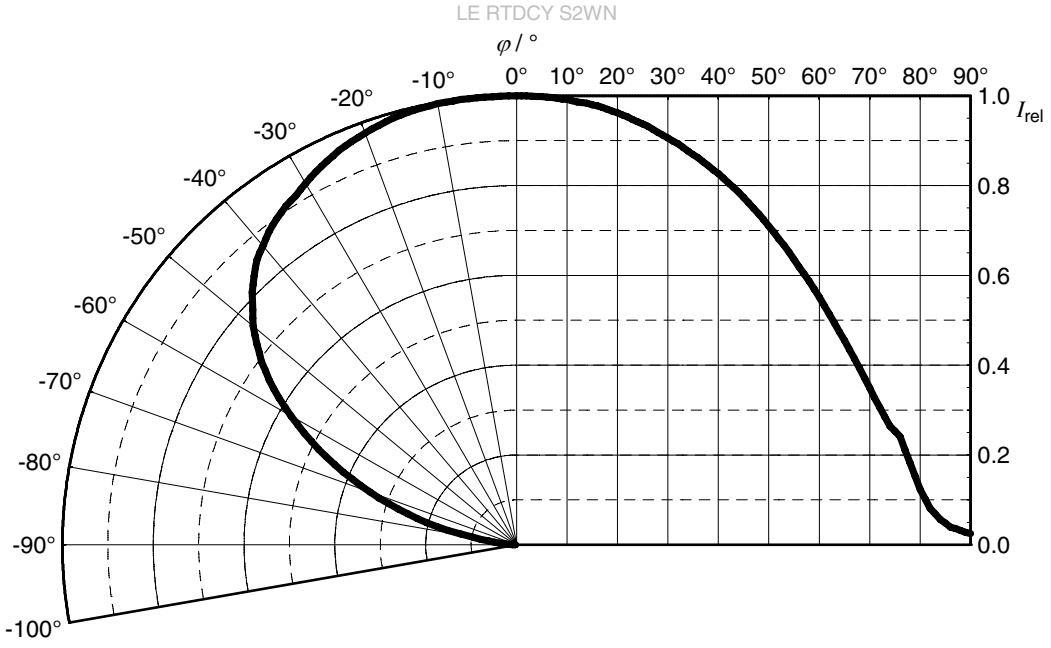
Radiation Characteristics [5)]

$I_{rel} = f(\phi)$; $T_J = 25$ °C; red, true green, deep blue



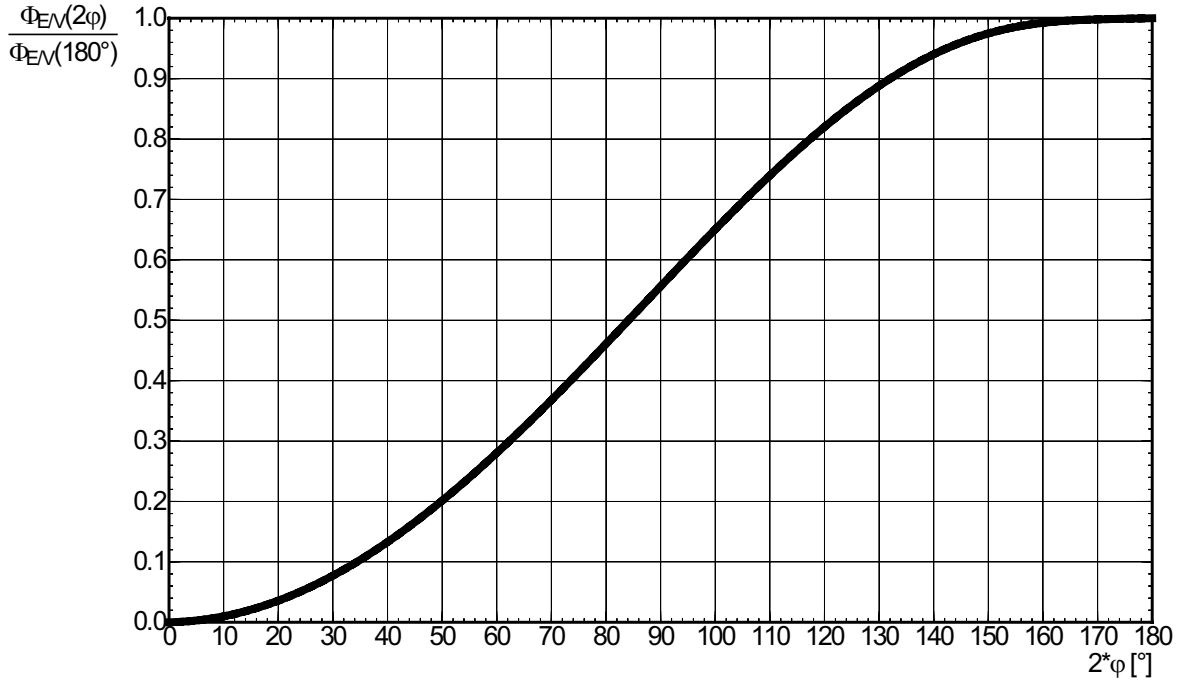
Radiation Characteristics [5)]

$I_{rel} = f(\phi)$; $T_J = 25$ °C; converted yellow



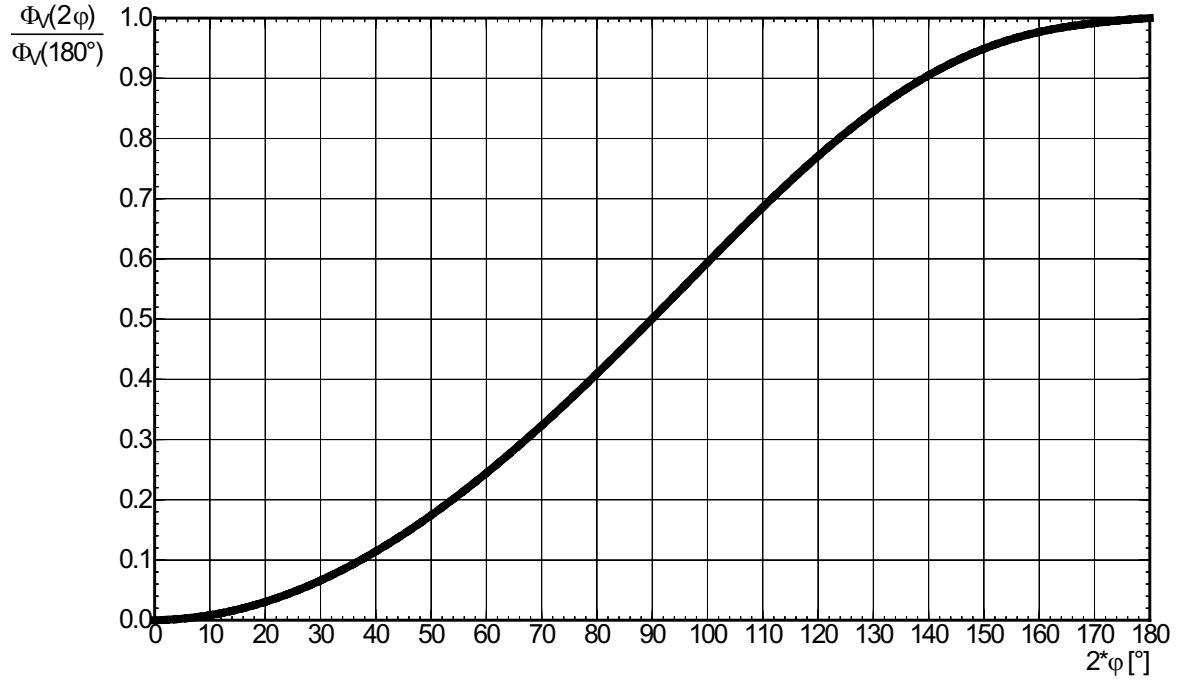
Relative Partial Flux [5)]

$\Phi_{E/V}(2\varphi)/\Phi_{E/V}(180°) = f(\varphi)$; T_J = 25 °C; red, true green, deep blue



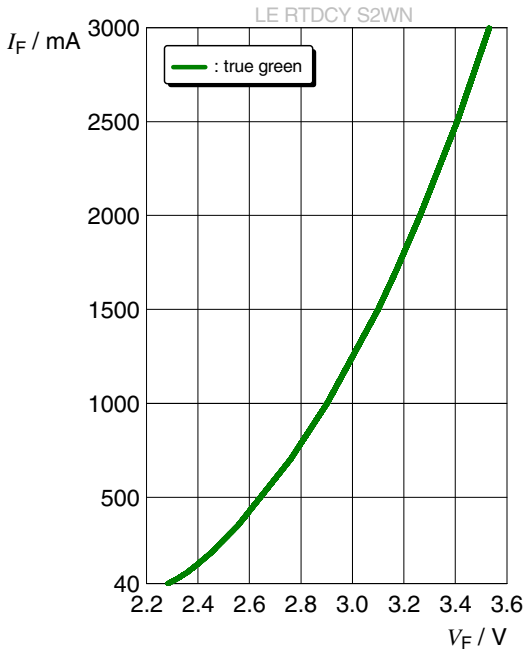
Relative Partial Flux [5)]

$\Phi_V(2\varphi)/\Phi_V(180°) = f(\varphi)$; T_J = 25 °C; converted yellow



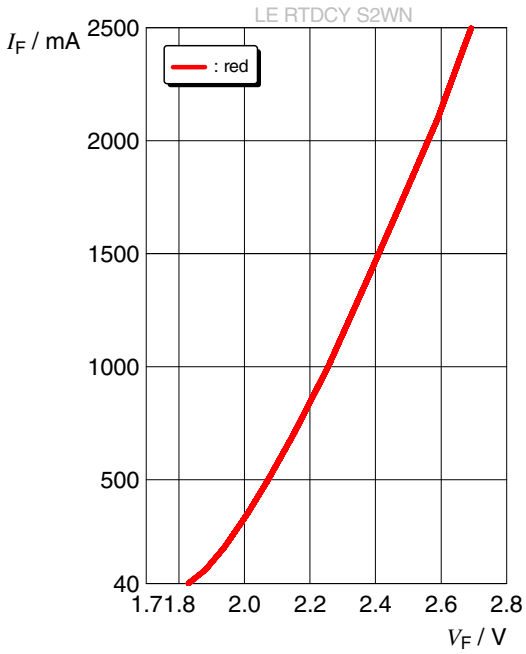
Forward current [5]

$I_F = f(V_F)$; $T_J = 25$ °C



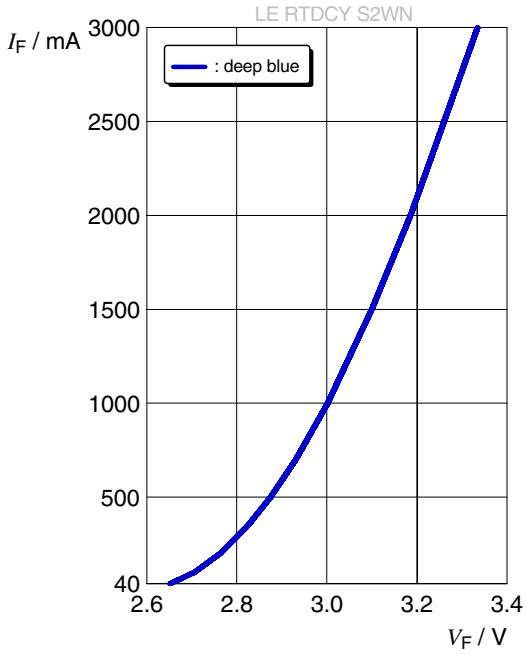
Forward current [5]

$I_F = f(V_F)$; $T_J = 25$ °C



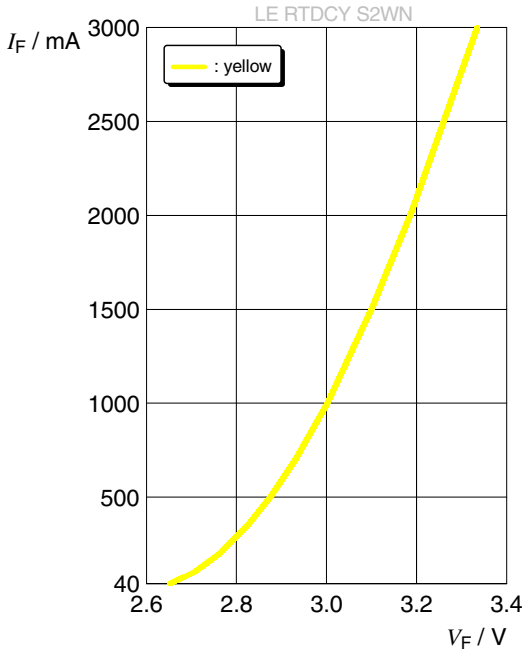
Forward current [5], [8]

$I_F = f(V_F)$; $T_J = 25$ °C



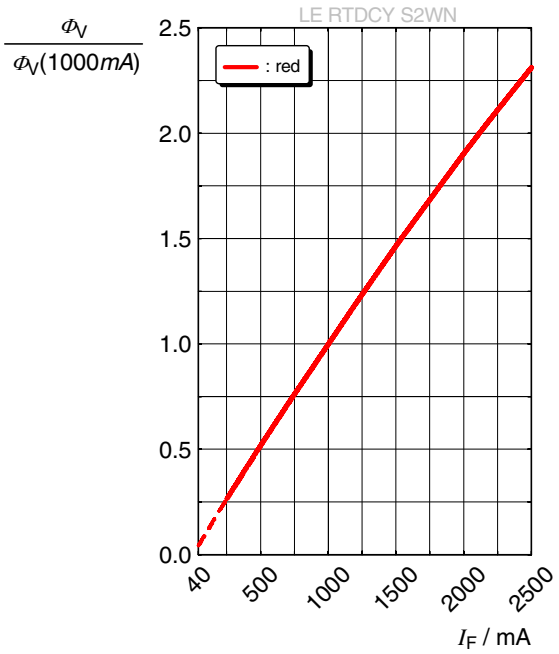
Forward current [5], [8]

$I_F = f(V_F)$; $T_J = 25$ °C



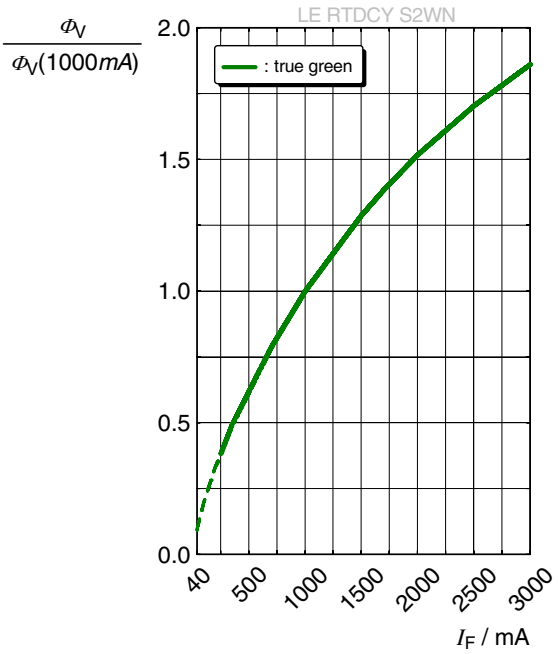
Relative Luminous Flux 5), 8)

$\Phi_v/\Phi_v(1000\ mA) = f(I_F);\ T_J = 25\ °C$



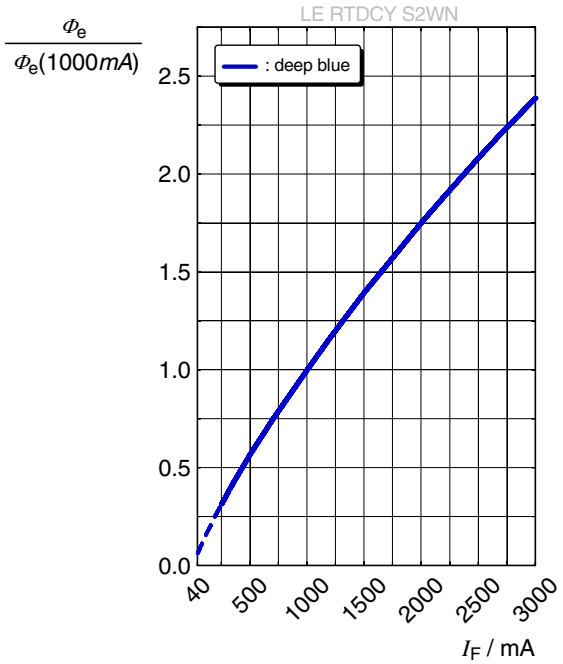
Relative Luminous Flux 5), 8)

$\Phi_v/\Phi_v(1000\ mA) = f(I_F);\ T_J = 25\ °C$



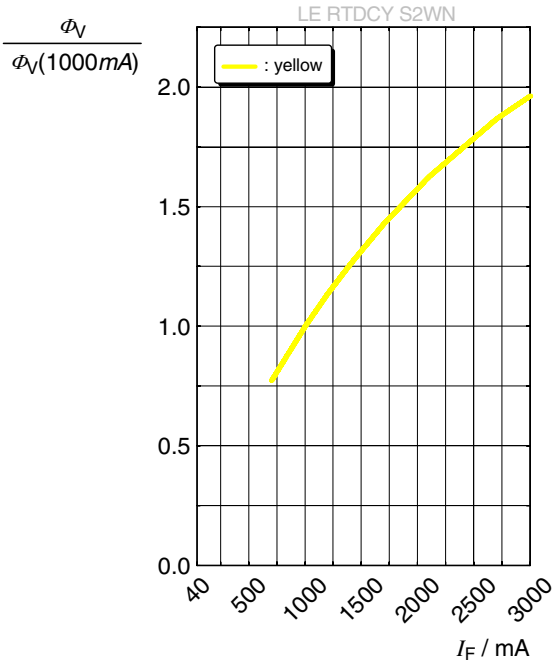
Relative Radiant Power 5), 8)

$\Phi_E/\Phi_E(1000\ mA) = f(I_F);\ T_J = 25\ °C$



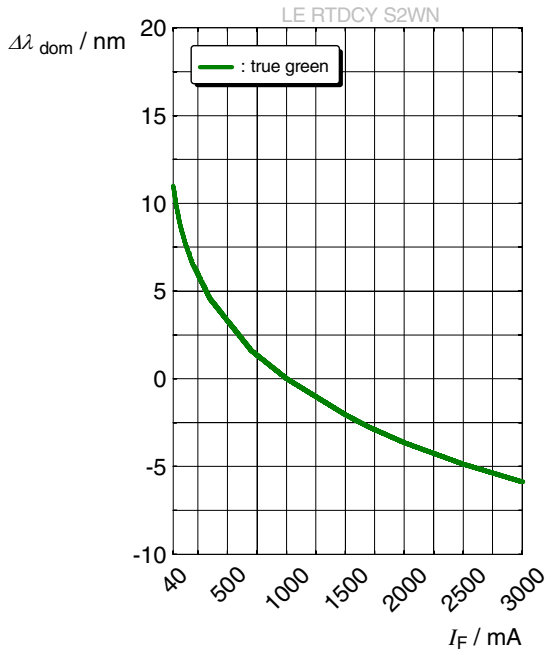
Relative Luminous Flux 5), 8)

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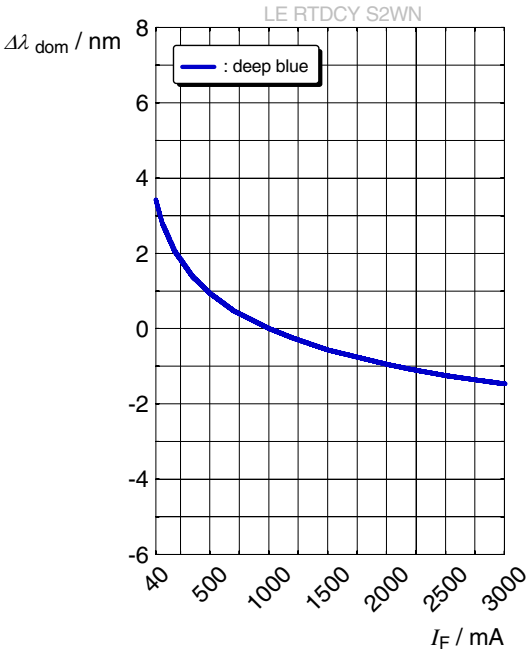
Dominant Wavelength [5]

$\Delta\lambda_{dom} = f(I_F); T_J = 25\ °C$



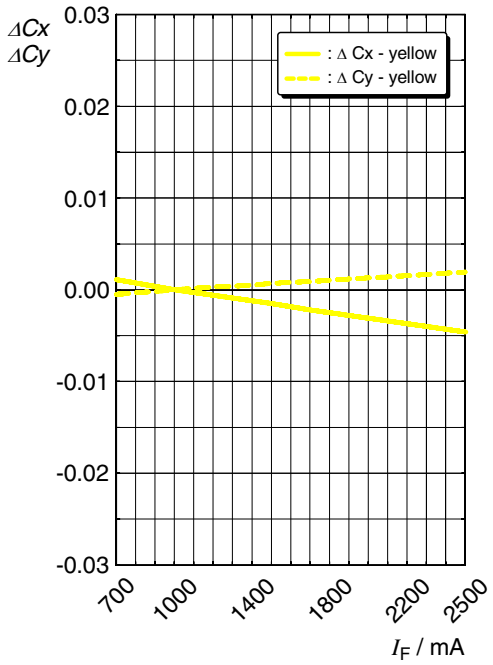
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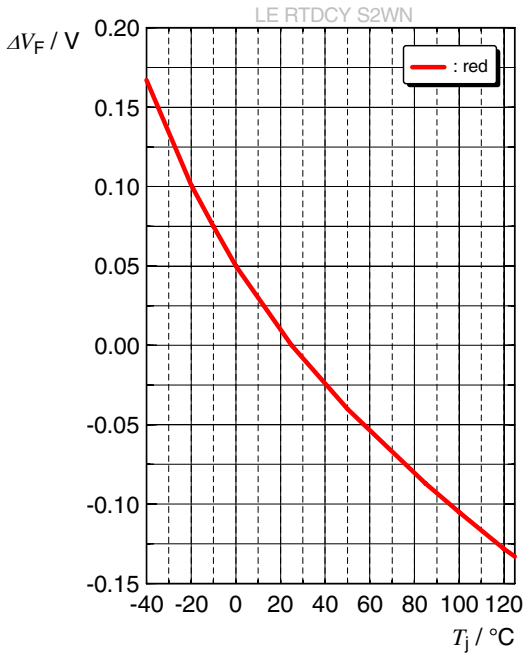
Chromaticity Coordinate Shift [5]

$\Delta Cx, \Delta Cy = f(I_F); T_J = 25\ °C$



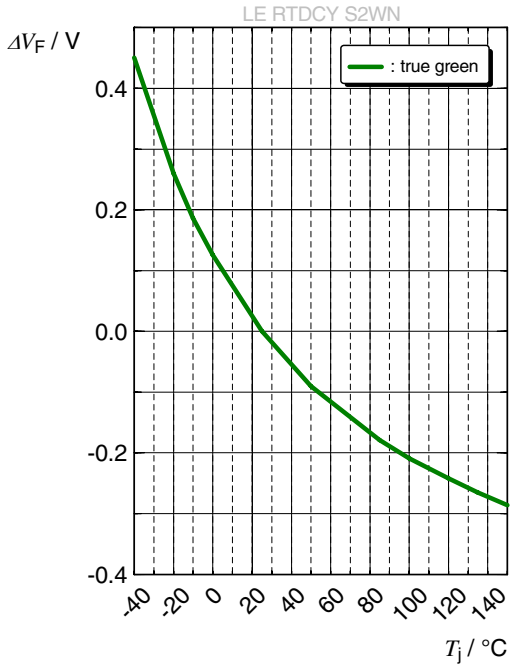
Forward Voltage [5)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 1000\ mA$



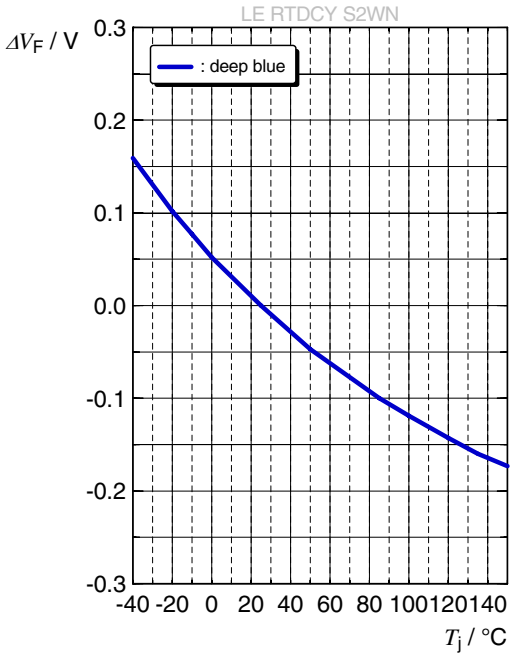
Forward Voltage [5)]

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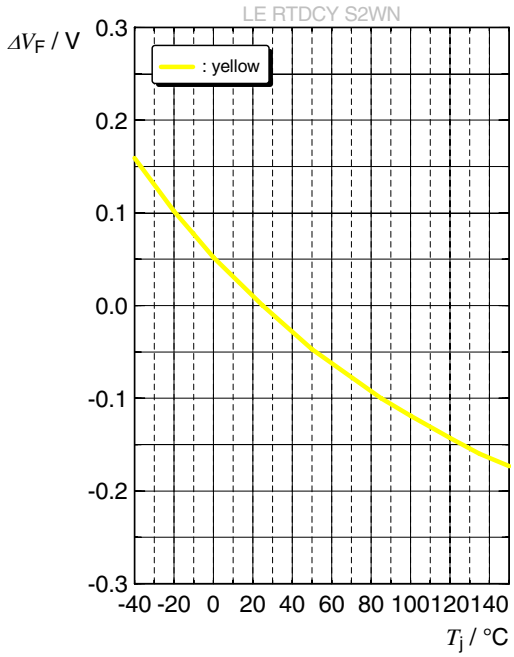
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$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 1000\ mA$



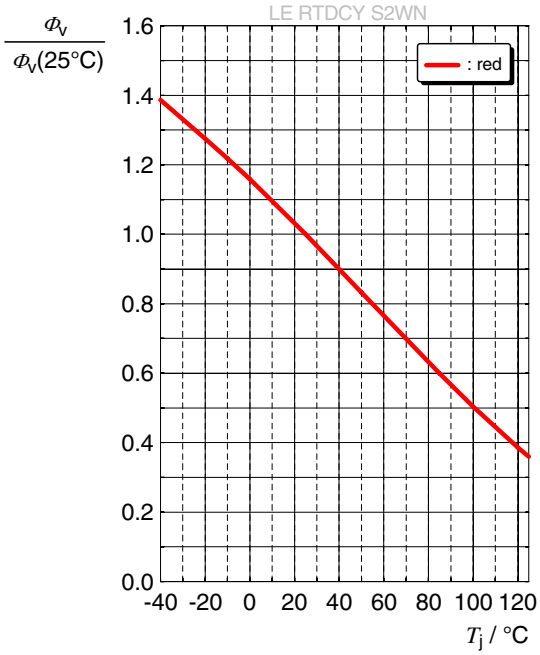
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$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 1000\ mA$



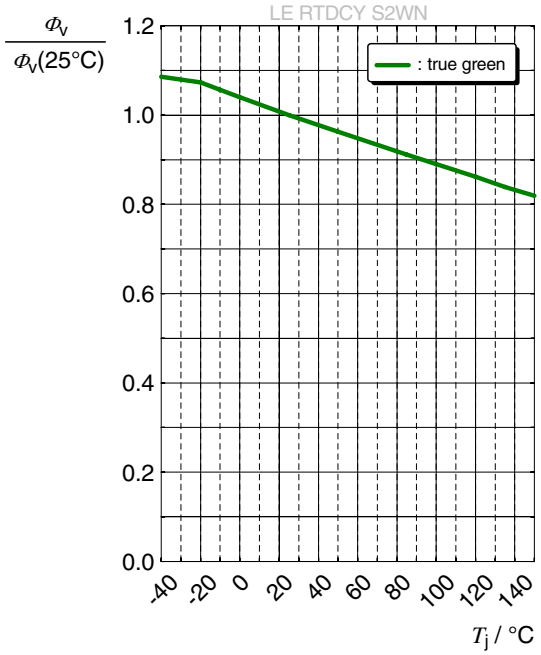
Relative Luminous Flux [5]

$\Phi_v/\Phi_v(25\ °C) = f(T_j);\ I_F = 1000\ mA$



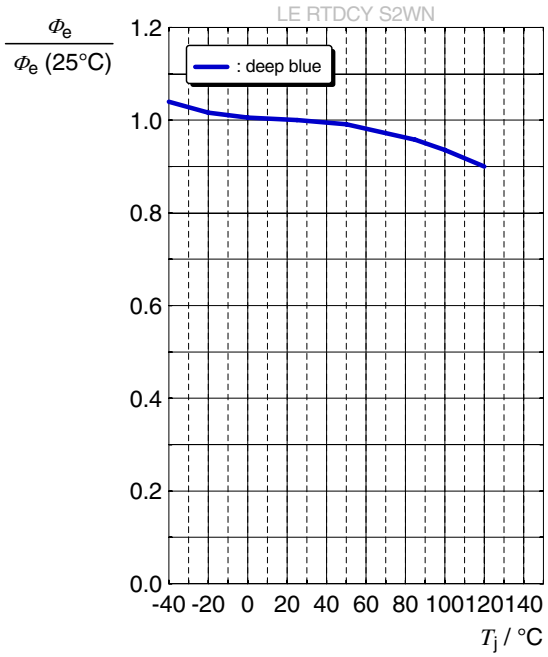
Relative Luminous Flux [5]

$\Phi_v/\Phi_v(25\ °C) = f(T_j);\ I_F = 1000\ mA$



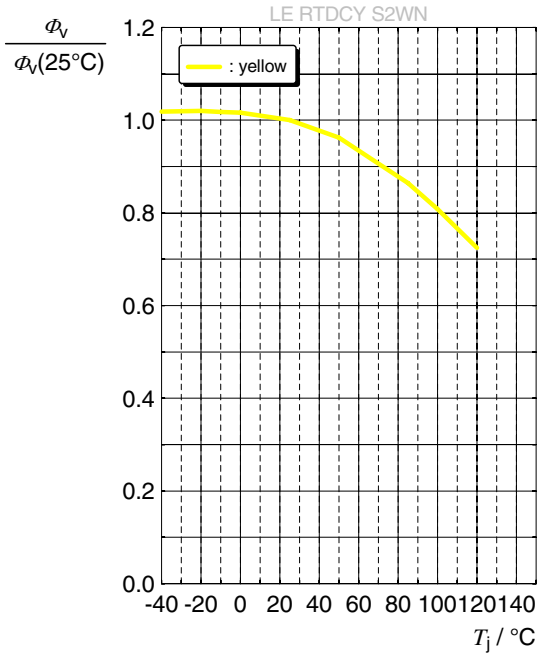
Relative Radiant Power [5]

$\Phi_E/\Phi_E(25\ °C) = f(T_j);\ I_F = 1000\ mA$



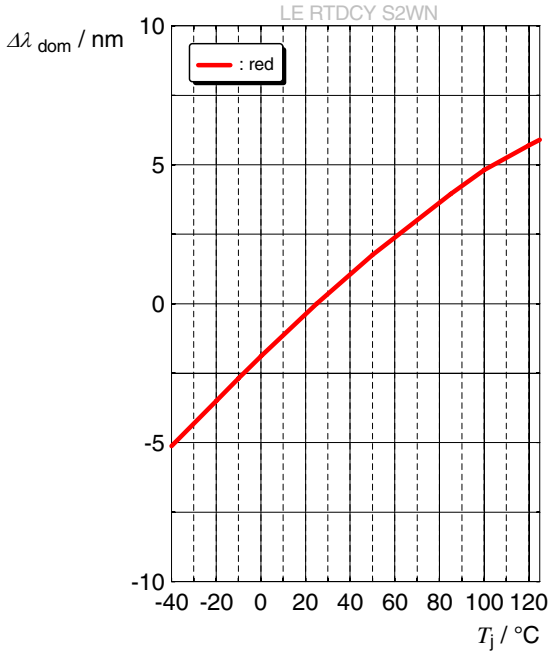
Relative Luminous Flux [5]

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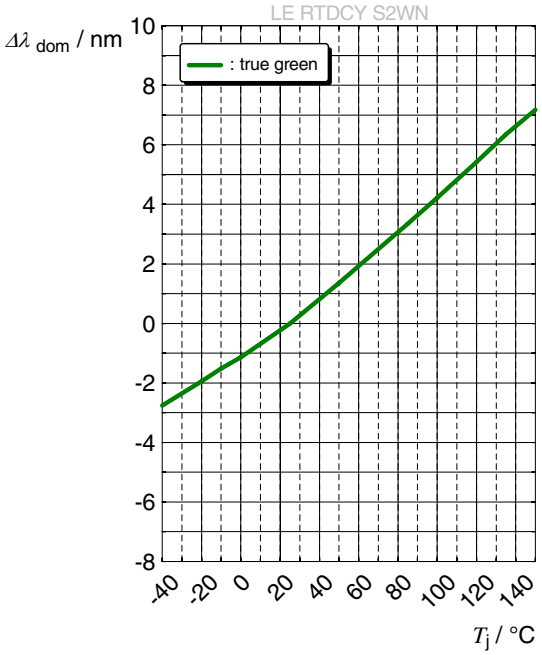
Dominant Wavelength [5)]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j);\ I_F = 1000\ mA$



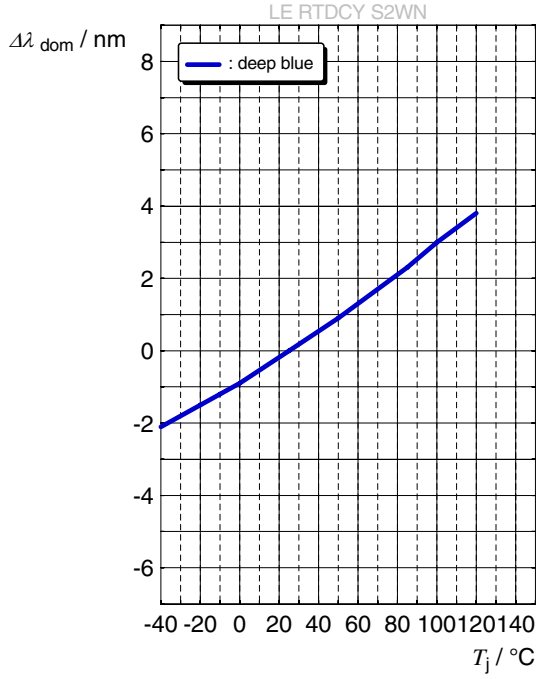
Dominant Wavelength [5)]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j);\ I_F = 1000\ mA$



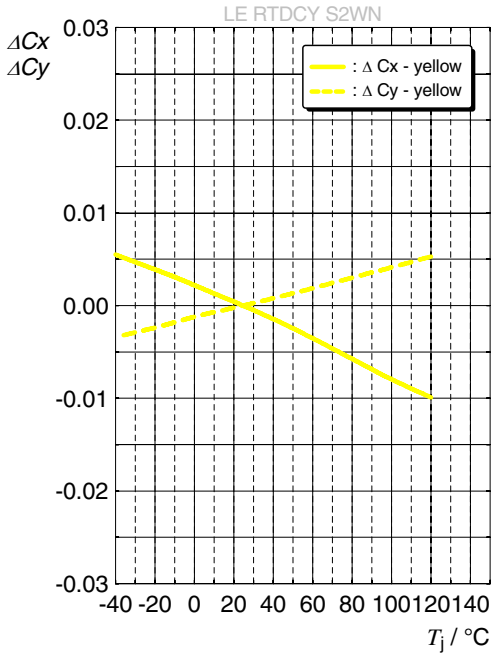
Dominant Wavelength [5)]

$\Delta\lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25\ °C) = f(T_j);\ I_F = 1000\ mA$



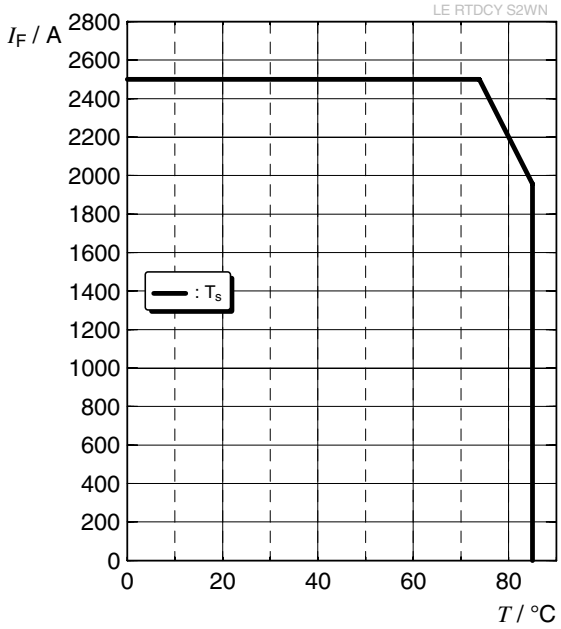
Chromaticity Coordinate Shift [5)]

$\Delta Cx, \Delta Cy = f(T_j);\ I_F = 1000\ mA$



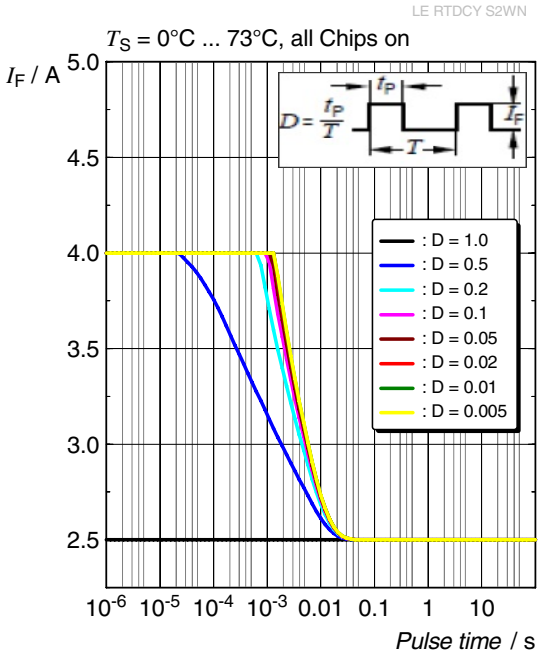
Max. Permissible Forward Current [7)]

I_F = f(T); 4 Chips operated; current per Chip



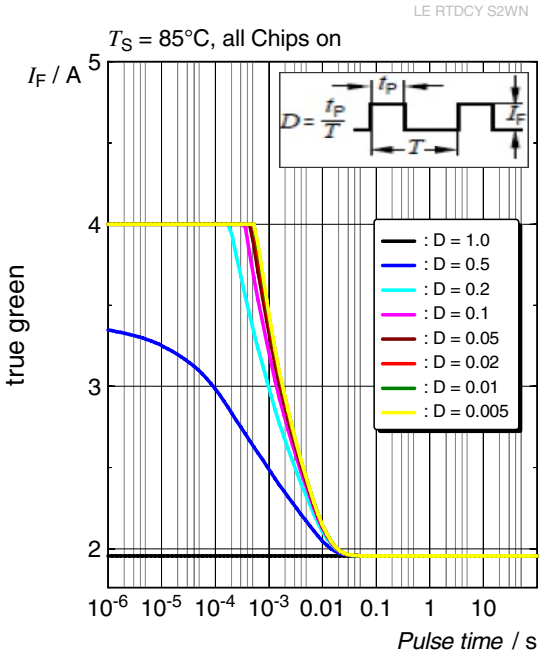
Permissible Pulse Handling Capability

I_F = f(T); 4 Chips operated; current per Chip

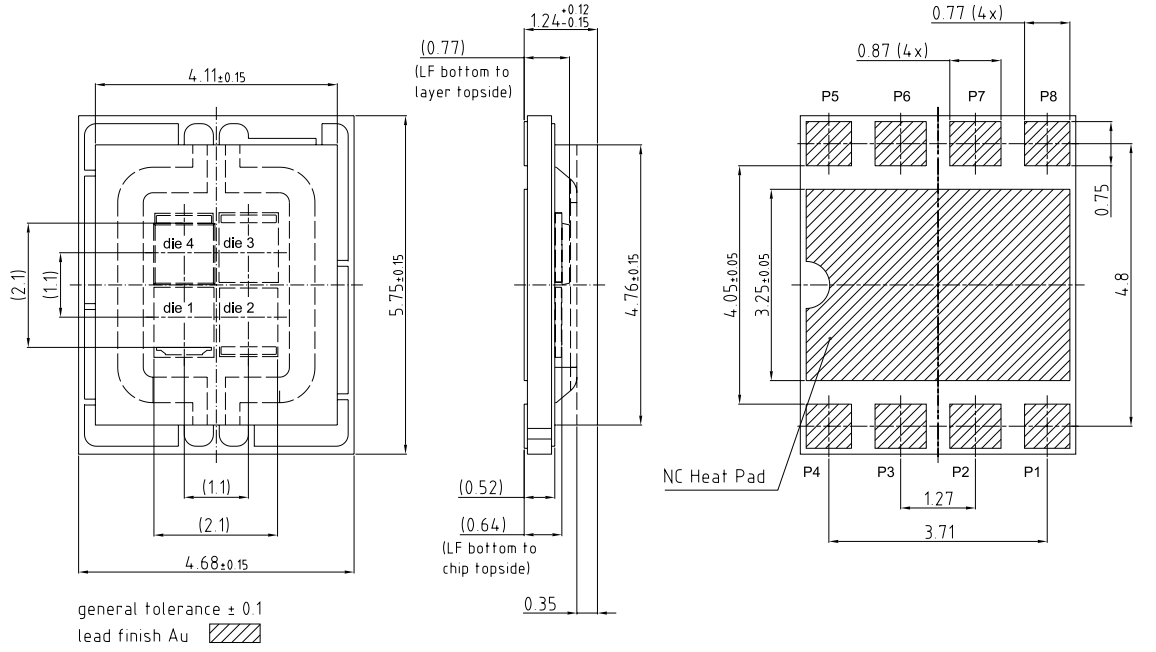


Permissible Pulse Handling Capability

I_F = f(tp); 4 Chips operated; current per Chip



Dimensional Drawing [9)]



C67062-A4278-A6-03

Further Information:

Approximate Weight: 91.0 mg

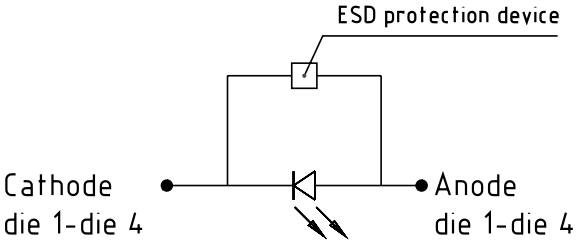
Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Electrical Internal Circuit

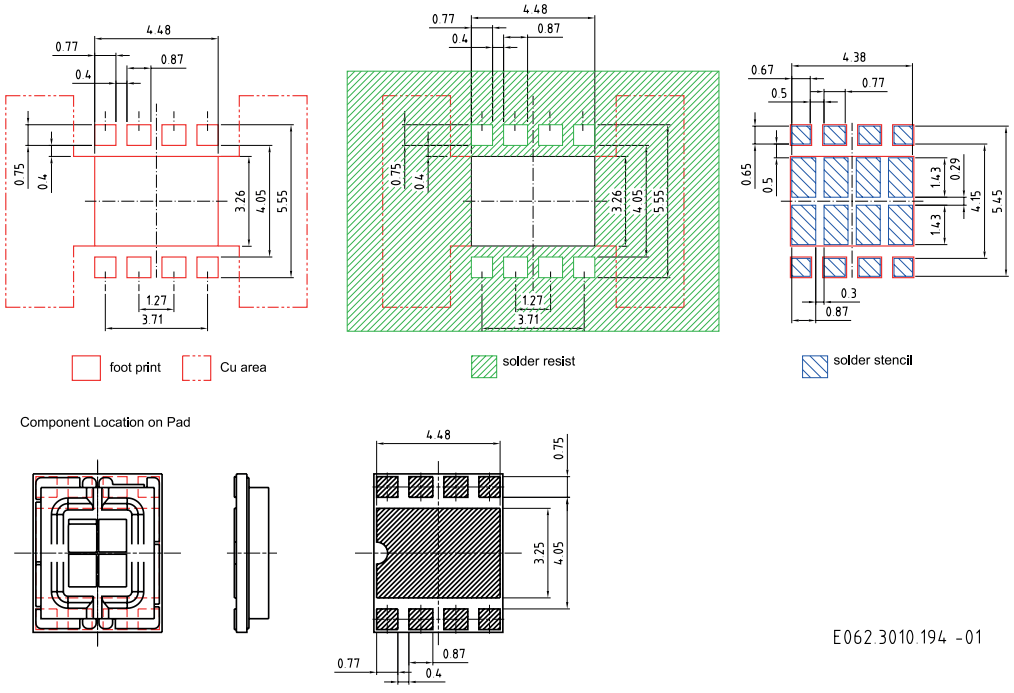
Pinning :

P1	Cathode die 1	P5	Cathode die 3
P2	Anode die 1	P6	Anode die 3
P3	Cathode die 2	P7	Cathode die 4
P4	Anode die 2	P8	Anode die 4



Colors :
die 1: red
die 2: deep blue
die 3: true green
die 4: converted yellow

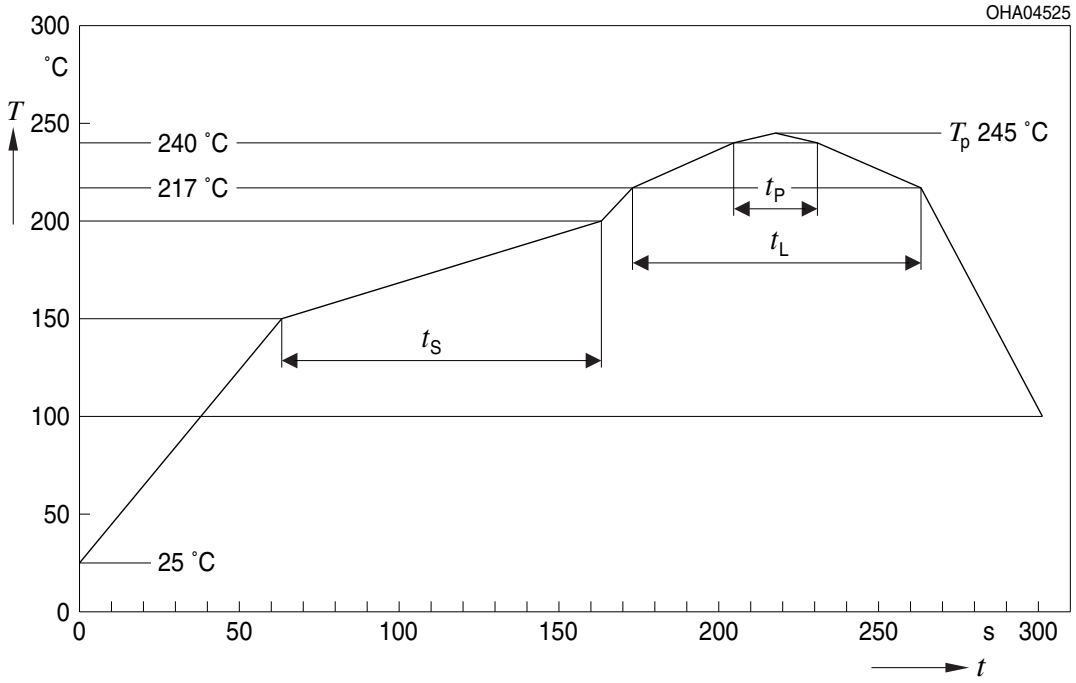
Recommended Solder Pad 9)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Reflow Soldering Profile

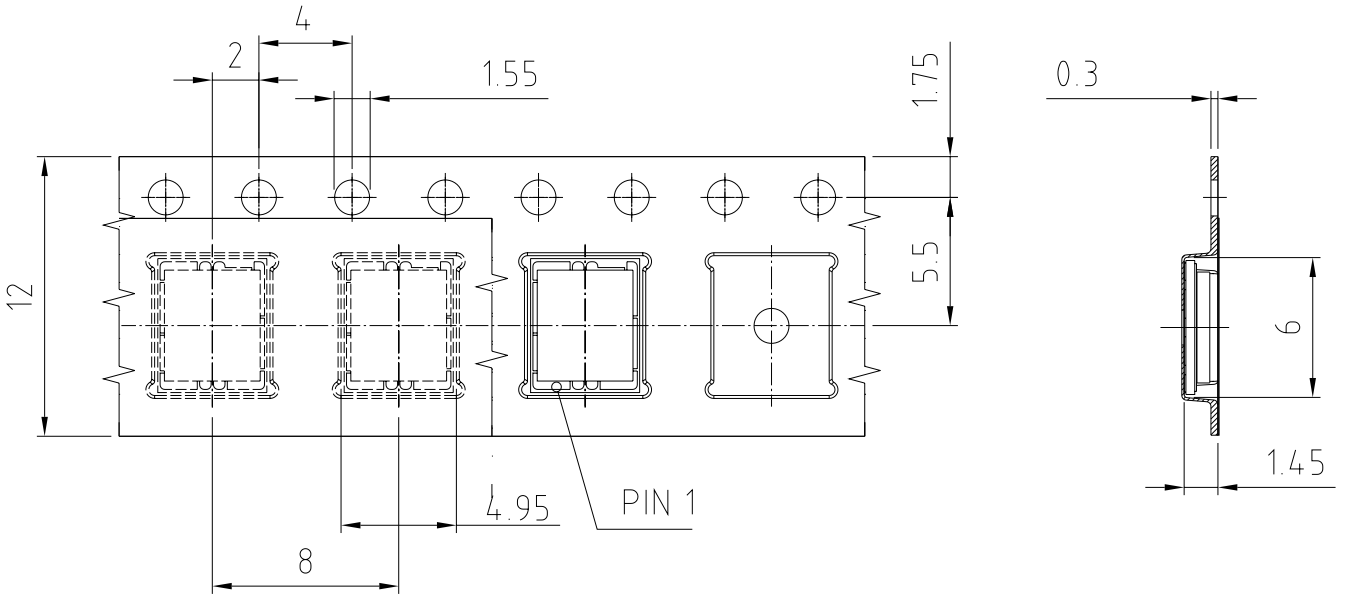
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

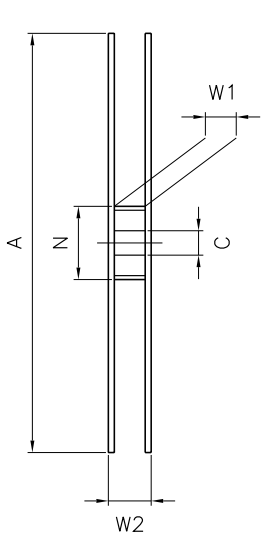
All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

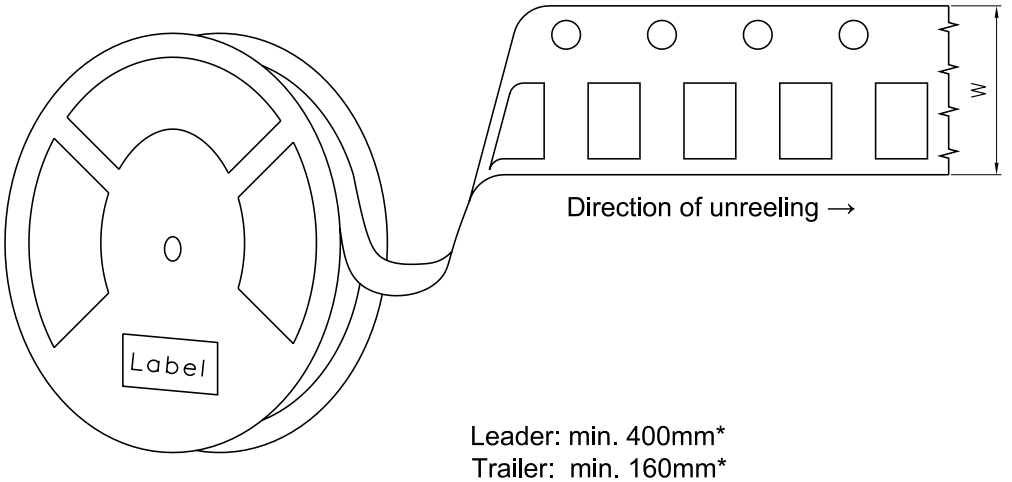
Taping [9)]



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Tape and Reel [10)]



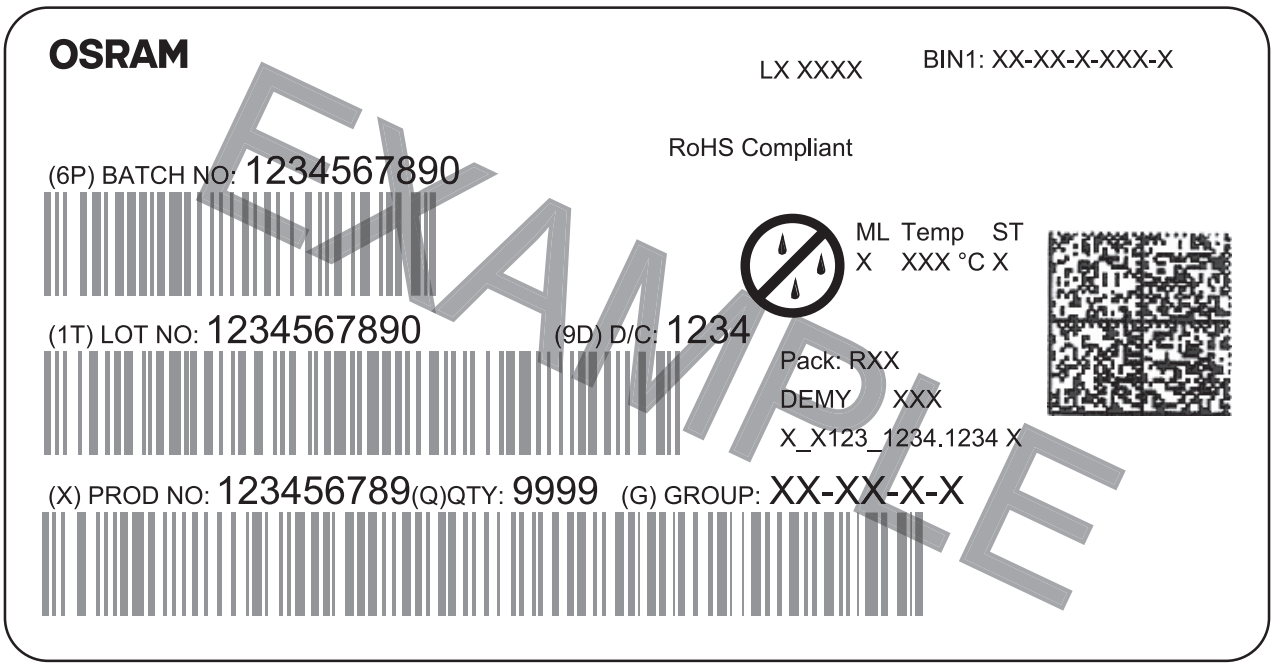


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

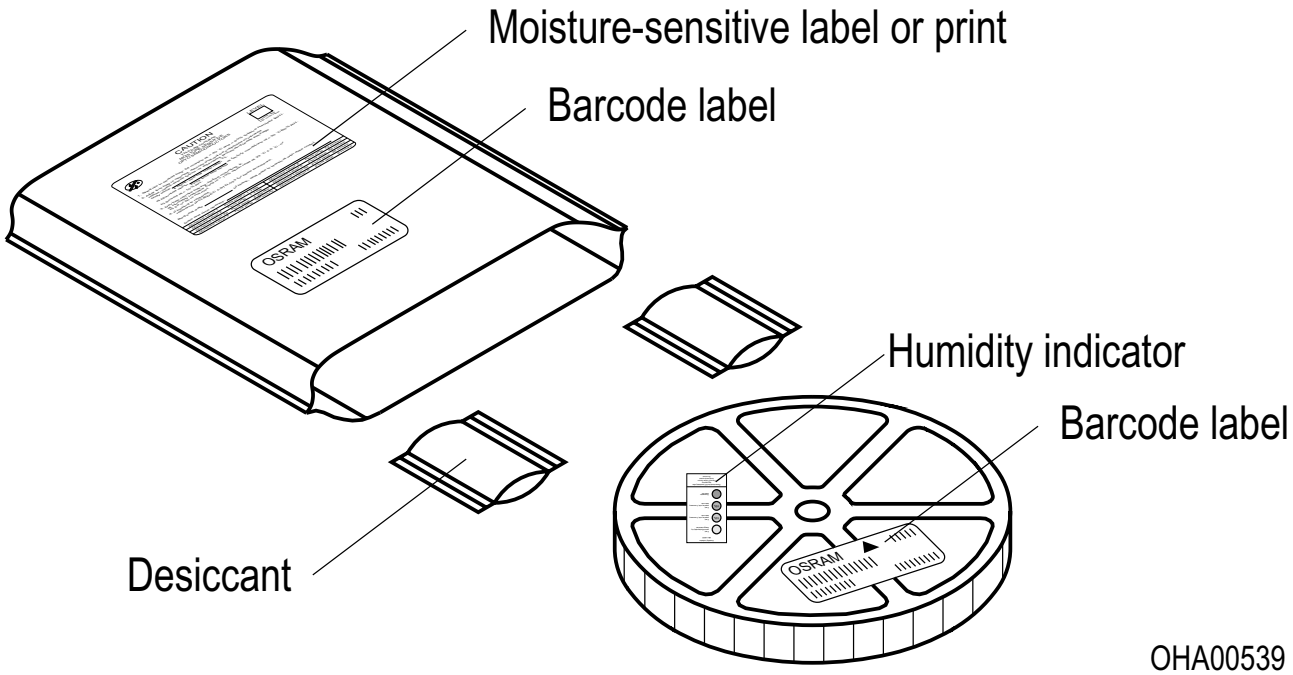
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	500

Barcode-Product-Label (BPL)



OHA04563

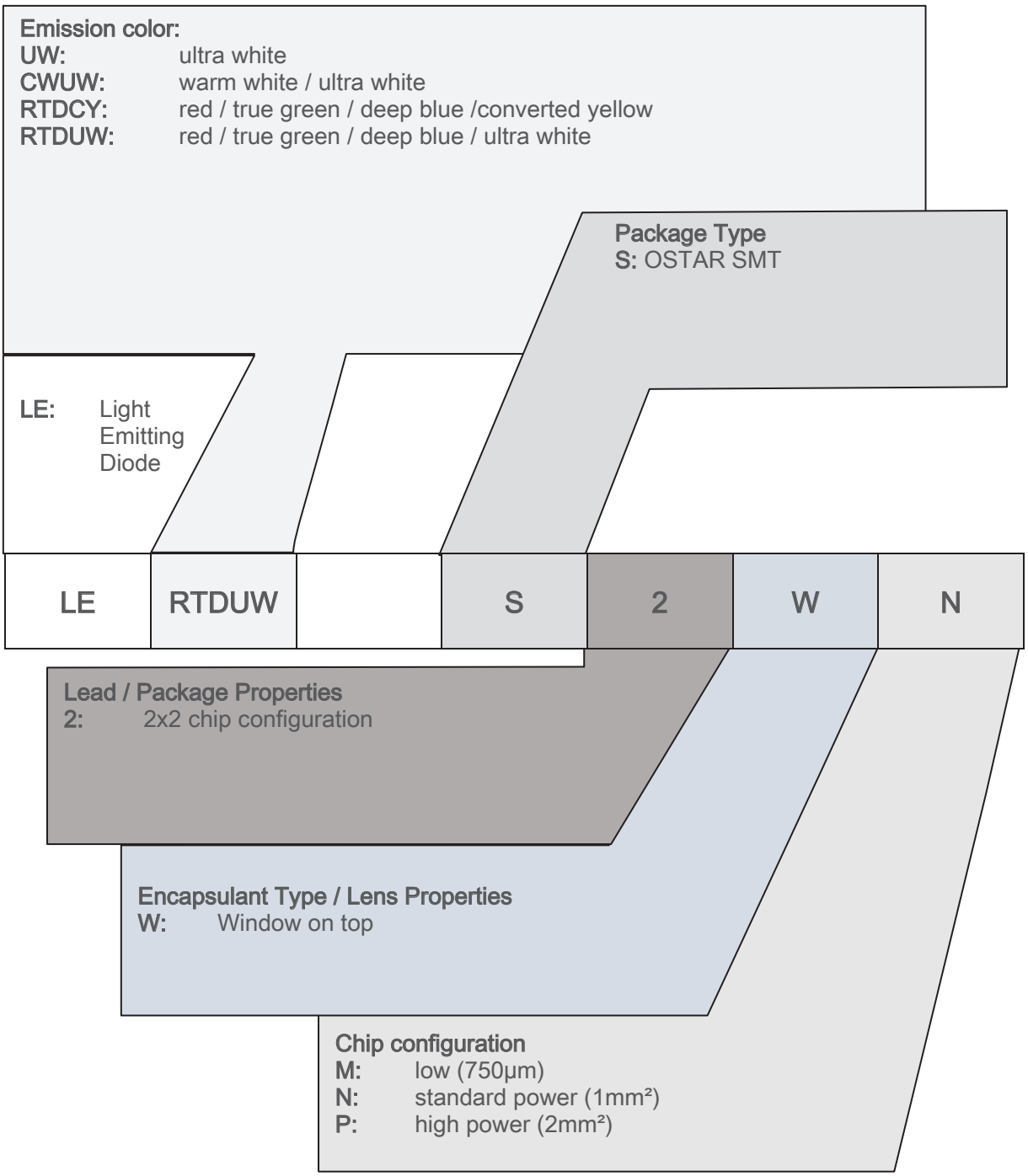
Dry Packing Process and Materials [9)]



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).

4) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).

5) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

6) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

7) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.4	2018-11-29	Characteristics
1.5	2018-12-17	Electrical Internal Circuit Dimensional Drawing
1.6	2019-02-04	Ordering Information
1.7	2019-06-06	Electro - Optical Characteristics (Diagrams)
1.8	2020-06-03	Schematic Transportation Box Dimensions of Transportation Box
1.9	2020-07-07	Characteristics
1.10	2020-07-17	Chromaticity Coordinate Groups
1.11	2022-10-06	Characteristics New Layout Electro - Optical Characteristics (Diagrams)
1.12	2026-02-24	Dimensional Drawing

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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